

Update Notification
Document #: FPCN21043X1
Issue Date: 26 July 2016

Title of Change:	PCN Update Notice – Cancellation of FPCN FPCN21043X which announced the transfer of the VHC1G, VHC1GT and SZ product family devices in the SC88A package to the TS18 wafer process at Tower Semiconductor and a change to the BOM for these same products to include Pd coated wire and Henkel mold compound.					
Proposed first ship date:	26 July 201	26 July 2016				
Contact information:	Contact yo	Contact your local ON Semiconductor Sales Office or <shero.gao@onsemi.com></shero.gao@onsemi.com>				
Samples:	Contact your local ON Semiconductor Sales Office					
Additional Reliability Data:	Contact your local ON Semiconductor Sales Office or <jose.aguilar@onsemi.com>.</jose.aguilar@onsemi.com>					
Type of notification:	ON Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <pcn.support@onsemi.com>.</pcn.support@onsemi.com>					
Change category:	⊠ Wafer	✓ Wafer Fab Change   ✓ Assembly Change   ☐ Test Change   X Other				
Change Sub-Category(s):  Manufacturing Site Change, Manufacturing Process Cha		<ul><li>✓ Material Change</li><li>✓ Product specific change</li></ul>		Shipping/I	☐ Datasheet/Product Doc change ☐ Shipping/Packaging/Marking Other:	
Sites Affected: ☐ All site(s) ☐ not ap			☑ ON Semiconductor site(s) : ON Leshan, China		⊠ External Foundry/Subcon site(s)     TOWER SEMICONDUCTOR LTD	
Description and Purpose:						
FPCN21043X was published on 10 September 2015 announcing the transfer of the VHC1G, VHC1GT and SZ product family devices in the SC88A package to the TS18 wafer process at Tower Semiconductor and a change to the BOM for these same products to include Pd coated wire and Henkel mold compound.  This Update Notification is being published to inform that the Final Process Change Notification FPCN21043X is canceled. Manufacturing will continue to supply the TS60 wafer technology with existing BOM.  There are no changes to electrical performance or reliability of the devices listed.						
List of affected Standard Parts:						
M74VHC1G125DFT1G	M74VHC1GT126DF2G		MC74VHC1G02DFT2G	МС7	4VHC1G50DFT1G	
M74VHC1G125DFT2G	M74VHC1GT14DFT1G		MC74VHC1G04DFT1G	MC7	4VHC1G50DFT2G	
M74VHC1G126DFT1G	//74VHC1GT14DFT2G		MC74VHC1G04DFT2G	MC7	4VHC1G86DFT1G	
M74VHC1G126DFT2G	174VHC1GT32DFT1G		MC74VHC1G05DFT1G	MC7	4VHC1G86DFT2G	
M74VHC1GT00DFT1G	M74VHC1GT32DFT2G		MC74VHC1G05DFT2G	MC7	4VHC1GU04DF1G	
M74VHC1GT00DFT2G	M74VHC1GT50DFT1G		MC74VHC1G07DFT1G	NL17	SZ07DFT2G	
M74VHC1GT02DFT1G	//74VHC1GT50DFT2G		MC74VHC1G07DFT2G	NL17	SZ125DFT2G	
M74VHC1GT02DFT2G	M74VHC1GT86DFT1G		MC74VHC1G08DFT1G	NL17	SZ08DFT2G	
M74VHC1GT04DFT1G	И74VHC1GT86DFT2G		MC74VHC1G08DFT2G	NL17	SZ32DFT2G	
M74VHC1GT04DFT2G	M74VHC1GU04DFT1G		MC74VHC1G09DFT1G	NL17	SZ00DFT2G	
M74VHC1GT04DFT3G	И74VHC1GU04DFT2G		MC74VHC1G09DFT2G	NL17	SZ04DFT2G	
M74VHC1GT08DFT1G	MC74VHC1G00DFT1G		MC74VHC1G125DFT1G	NL17	SZ126DFT2G	
M74VHC1GT08DFT2G	/IC74VHC1G00DFT2G		MC74VHC1G14DFT1G	NL17	SZ06DFT2G	
M74VHC1GT125DF1G	MC74VHC1G	01DFT1G	MC74VHC1G14DFT2G	NL17	SZ02DFT2G	
M74VHC1GT125DF2G	MC74VHC1G	01DFT2G	MC74VHC1G32DFT1G	NL17	SZ86DFT2G	
M74VHC1GT126DF1G	MC74VHC1G02DFT1G		MC74VHC1G32DFT2G	NL17	SZ16DFT2G	

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